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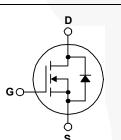
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## N-Channel QFET<sup>®</sup> MOSFET 150 V, 50 A, 42 mΩ

#### Features

- + 50 A, 150 V,  ${\sf R}_{{\sf DS}({\sf on})}$  = 42 m $\Omega$  (Max) @V\_{{\sf GS}} = 10 V, I\_D = 25 A
- Low Gate Charge (Typ. 85 nC)
- Low Crss (Typ. 100 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating



control, and variable switching power applications.

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar

stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state

resistance, and to provide superior switching performance and

high avalanche energy strength. These devices are suitable for

switched mode power supplies, audio amplifier, DC motor

Description

#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQA46N15	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		150	V	
I <sub>D</sub>	Drain Current - Continuous ( $T_c = 25^{\circ}C$ )		50	А	
	- Continuous (T <sub>C</sub> = 100°C)		35.3	А	
DM	Drain Current - Pulsed	(Note 1)	200	А	
V <sub>GSS</sub>	Gate-Source Voltage		± 25	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	650	mJ	
AR	Avalanche Current	(Note 1)	50	A	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	25	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns	
P <sub>D</sub>	Power Dissipation ( $T_C = 25^{\circ}C$ )		250	W	
	- Derate above 25°C		1.67	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

TO-3PN

#### **Thermal Characteristics**

Symbol	Parameter	FQA46N15	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.6	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

Package	Marking	and	Ordering	Information
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Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA46N15	FQA46N15	TO-3PN	Tube	N/A	N/A	30 units

### Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A	150			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , Referenced to 25°C		0.16		V/°C
I <sub>DSS</sub> Zer	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 150 V, V <sub>GS</sub> = 0 V			1	μA
		V <sub>DS</sub> = 120 V, T <sub>C</sub> = 150°C			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS}$ = 25 V, $V_{DS}$ = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS}$ = -25 V, $V_{DS}$ = 0 V			-100	nA
On Charact	teristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25A		0.033	0.042	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 25A		36		S
Dynamic Cl	haracteristics					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,		2500	3250	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		520	670	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			100	130	pF
Switching C	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 45.6A,		35	80	ns
t <sub>r</sub>	Turn-On Rise Time	- R <sub>G</sub> = 25 Ω 		320	650	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			210	430	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		200	410	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 120 V, I <sub>D</sub> = 45.6A,		85	110	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V		15		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4)	-	41		nC
Drain-Source	ce Diode Characteristics and Maximum Ratings	3			/	
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				50	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				200	А
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> =50A			1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 45.6 A,		130		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs		0.55		μC

NOTES:

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 0.43 mH, I\_{AS} = 50 A, V\_{DD} = 25 V, R\_G = 25  $\Omega,$  starting T\_J = 25°C.

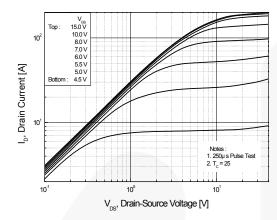
 $3.I_{SD} \leq 46.6$  A, di/dt  $\leq 300$  A/µs,  $V_{DD} \leq BV_{DSS},$  starting  $T_J$  = 25°C.

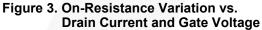
4. Essentially independent of operating temperature typical characteristics.

### **Typical Performance Characteristics**



#### **Figure 2. Transfer Characteristics**





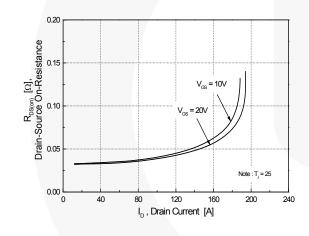
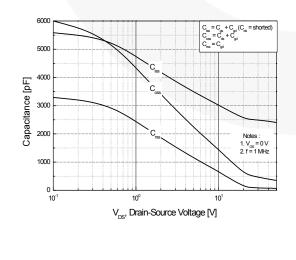
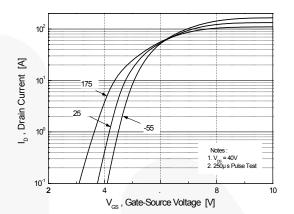
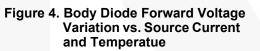
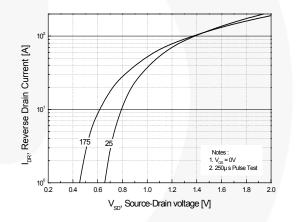


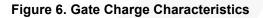
Figure 5. Capacitance Characteristics

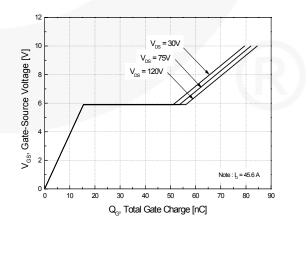


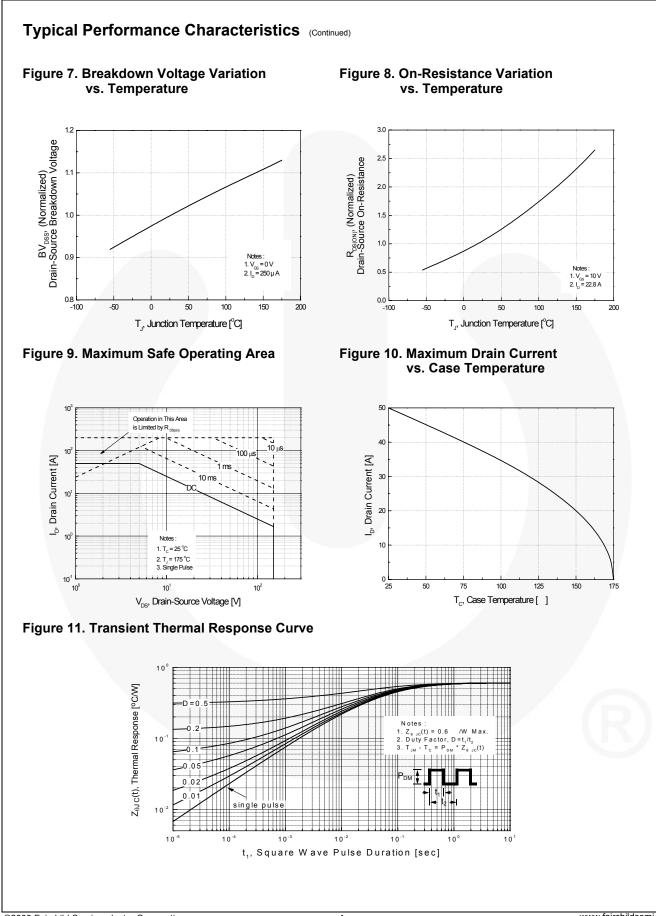






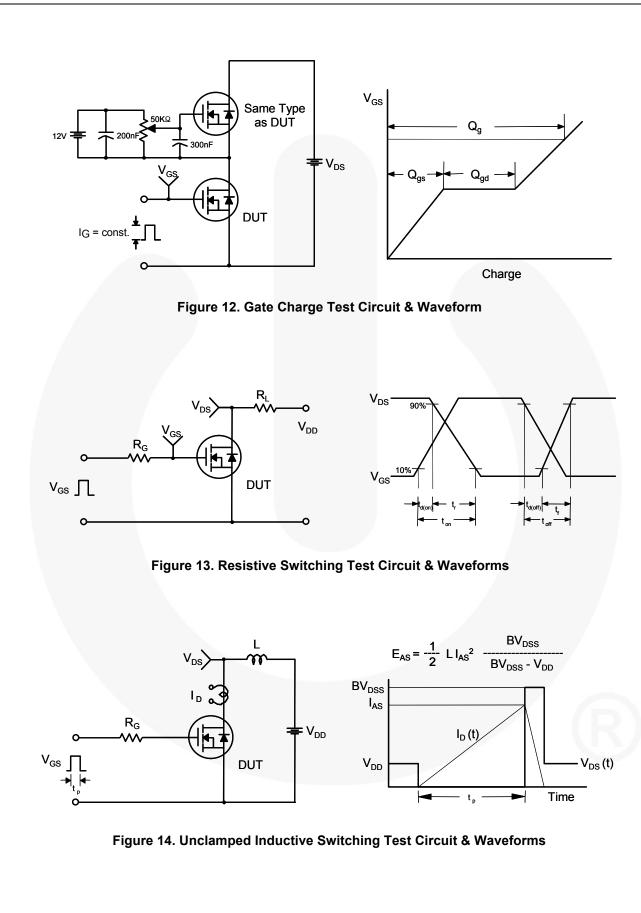


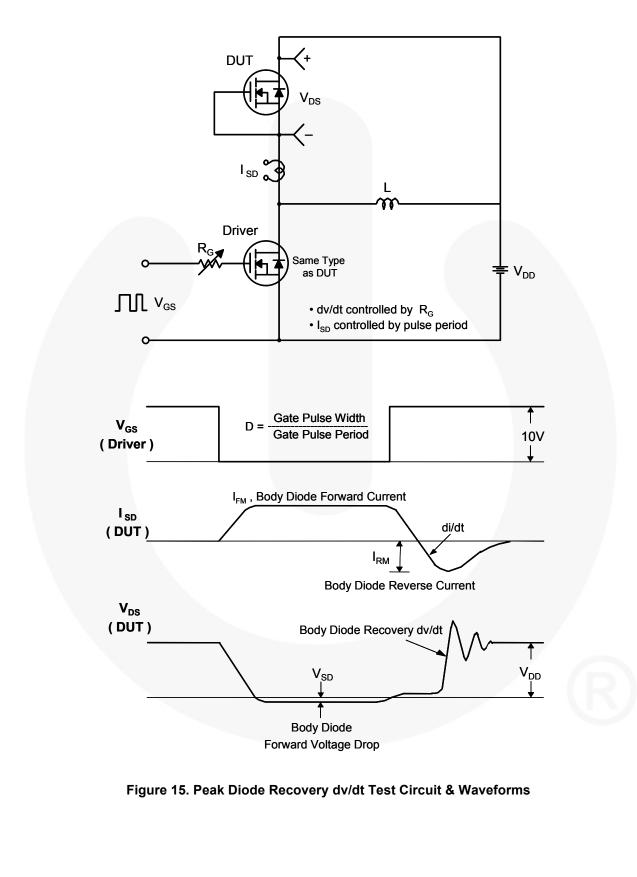


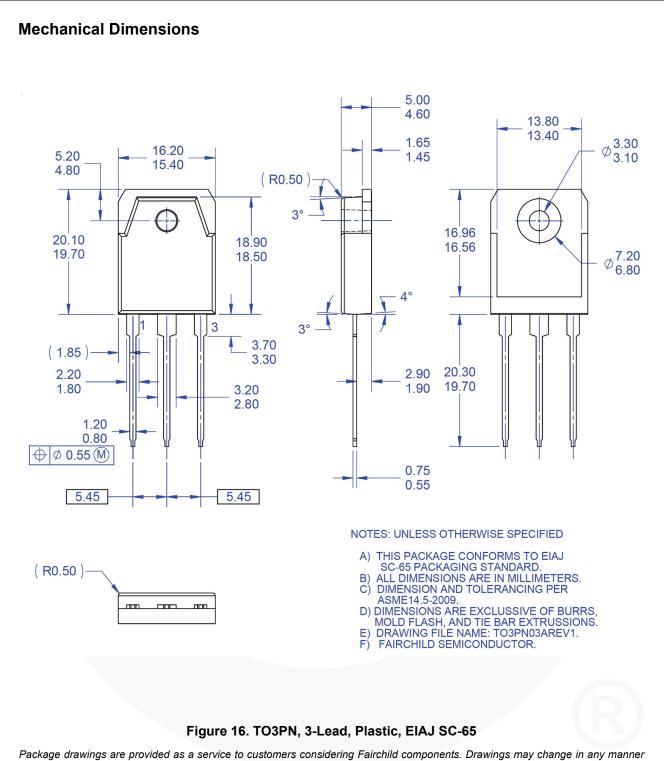


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FQA46N15 — N-Channel QFET<sup>®</sup> MOSFET







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Not In Production

Obsolete

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